Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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EVERLIGHT ELECTRONICS CO., LTD.

Technical Data Sheet

Mini Top LEDs (Reverse Gull Wing)

65-21/G6C-AQ1R2B/2AA

Features

- White SMT package.
- Optical indicator.
- Wide viewing angle.
- Soldering methods: IR reflow soldering
- Available on tape and reel
- Pb-free
- The product itself will remain within RoHS compliant version.

Descriptions

The 65-21 series is available in soft orange, green, blue, and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. Besides, LED is mounted top down and emits through the PCB. This feature makes the ideal for light pipe application.

Applications

- Optical indicators.
- Coupling into light guides.
- Backlighting (LCD, cellular phones, switches, keys, displays, illuminated advertising, general lighting).
- Coupling into light guides; Interior automotive lighting (e.g. dashboard backlighting, etc.).

Device Selection Guide

Chip Material	Emitted Color	Resin Color
AlGaInP	Brilliant Yellow Green	Water Clear

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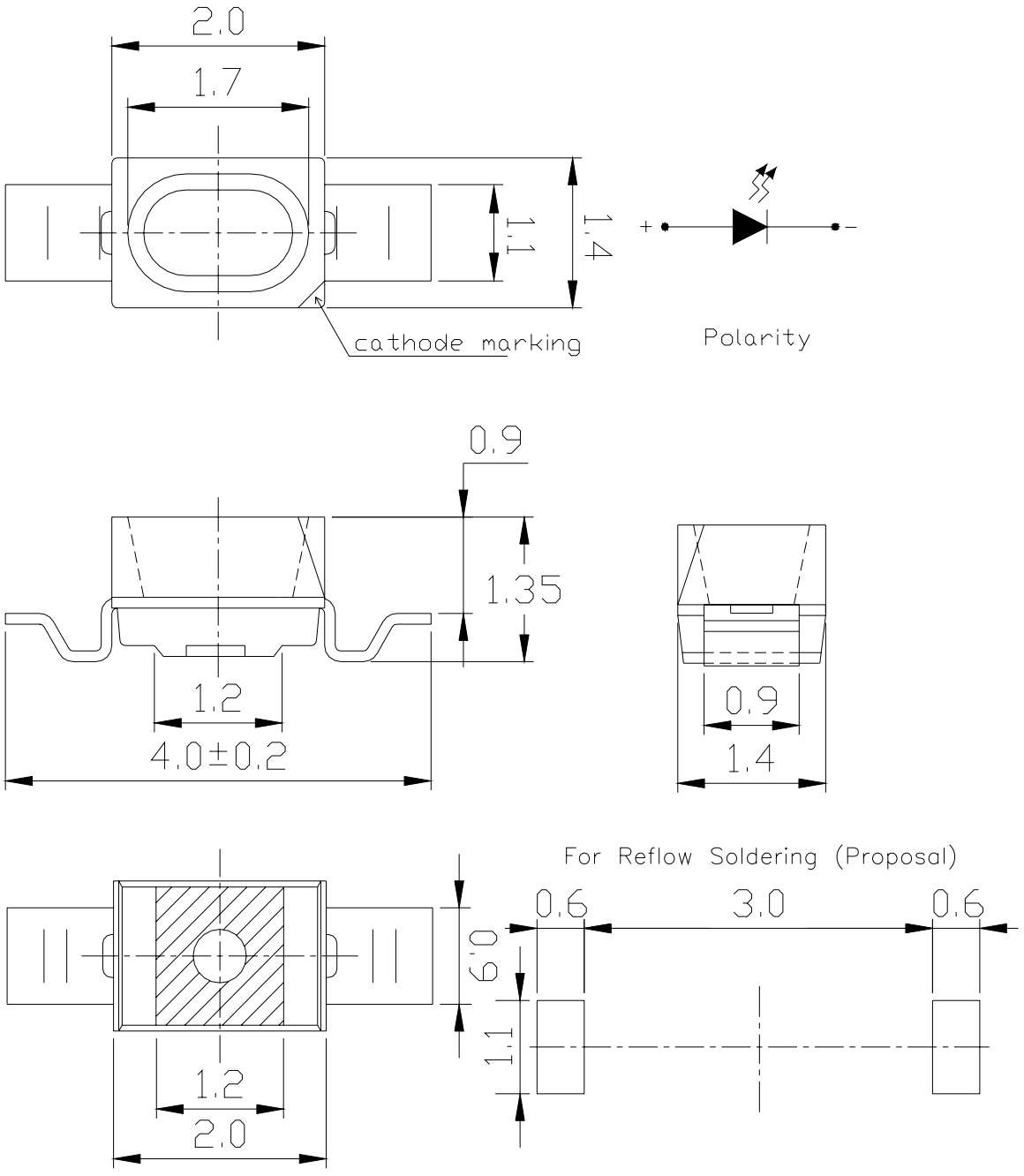
Package Outline Dimensions



Note: Tolerance unless mentioned is ±0.1mm; Unit = mm

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Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	25	mA
Power Dissipation	Pd	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	60	mA
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40 ~ +85	℃
Storage Temperature	Tstg	-40 ~ +90	℃
Soldering Temperature	Tsol	Reflow Soldering : 260 ℃ for 10 sec. Hand Soldering : 350 ℃ for 3 sec.	

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv	72	-----	180	mcd	I_F=20mA
Viewing Angle	2θ1/2	-----	120	-----	deg	I_F=20mA
Peak Wavelength	λp	-----	575	-----	nm	I_F=20mA
Dominant Wavelength	λd	569.5	-----	577.5	nm	I_F=20mA
Spectrum Radiation Bandwidth	Δλ	-----	20	-----	nm	I_F=20mA
Forward Voltage	V_F	1.75	-----	2.35	V	I_F=20mA
Reverse Current	I_R	-----	-----	10	μA	V_R=5V

Notes:

1. Tolerance of Luminous Intensity: ±11%
2. Tolerance of Dominant Wavelength: ±1nm
3. Tolerance of Forward Voltage: ±0.1V

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Mini Top LEDs (Reverse Gull Wing)

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Bin Range of Dominant Wavelength

Group	Bin	Min	Max	Unit	Condition
A	C16	569.5	571.5	nm	I_F=20mA
	C17	571.5	573.5		
	C18	573.5	575.5		
	C19	575.5	577.5		

Bin Range of Luminous Intensity

Bin	Min	Max	Unit	Condition
Q1	72	90	mcd	I_F=20mA
Q2	90	112		
R1	112	140		
R2	140	180		

Bin Range of Forward Voltage

Group	Bin	Min	Max	Unit	Condition
B	0	1.75	1.95	V	I_F=20mA
	1	1.95	2.15		
	2	2.15	2.35		

Notes:

1. Tolerance of Luminous Intensity: ±11%
2. Tolerance of Dominant Wavelength: ±1nm
3. Tolerance of Forward Voltage: ±0.1V

Technical Data Sheet

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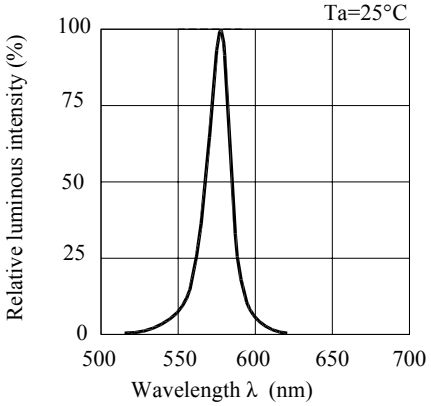
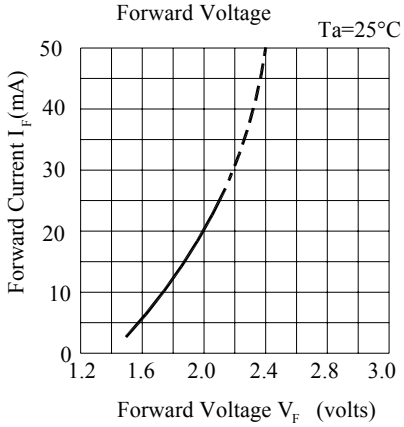
Typical Electro-Optical Characteristics Curves

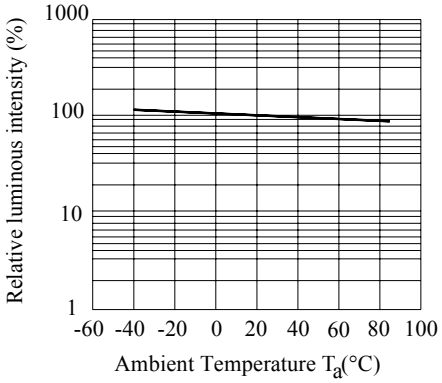
Spectrum Distribution



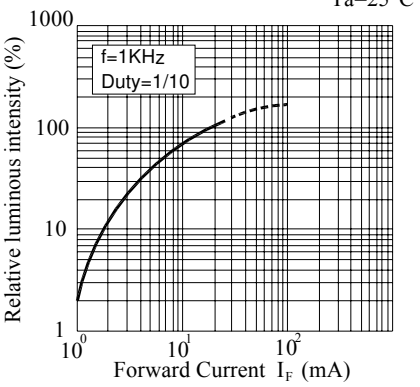
Forward Current vs. Forward Voltage



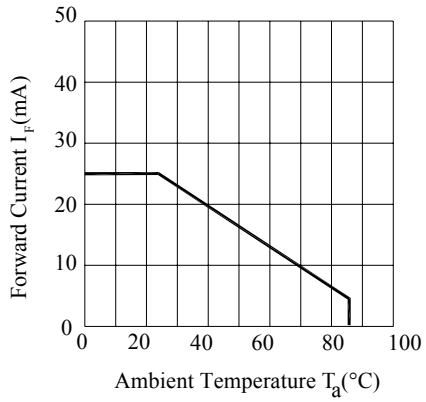
Relative Luminous Intensity vs. Ambient Temperature



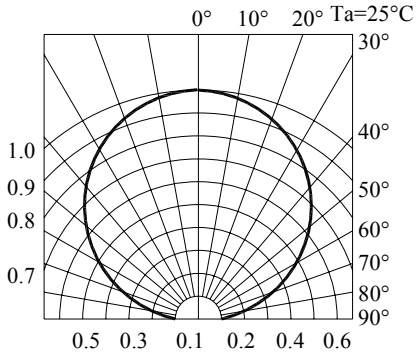
Relative Luminous Intensity vs. Forward Current



Forward Current Derating Curve



Radiation Diagram



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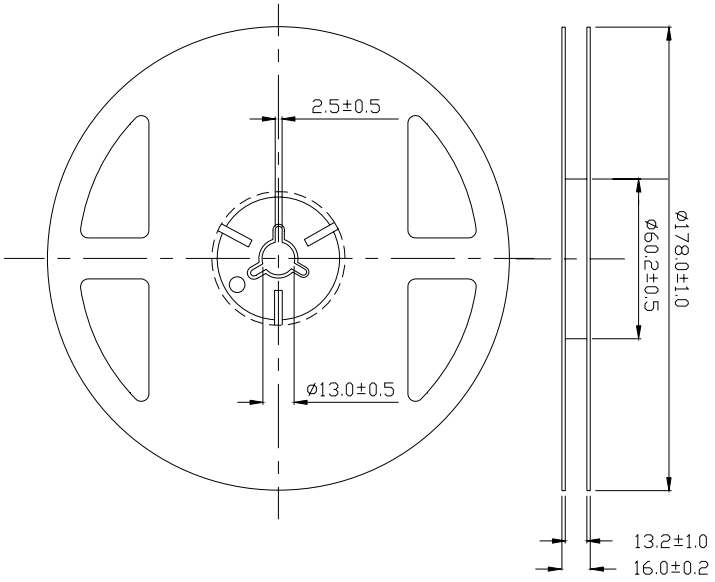
Label Explanation

CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

Reel Dimensions



Note: Tolerance unless mentioned is ±0.1mm; Unit = mm

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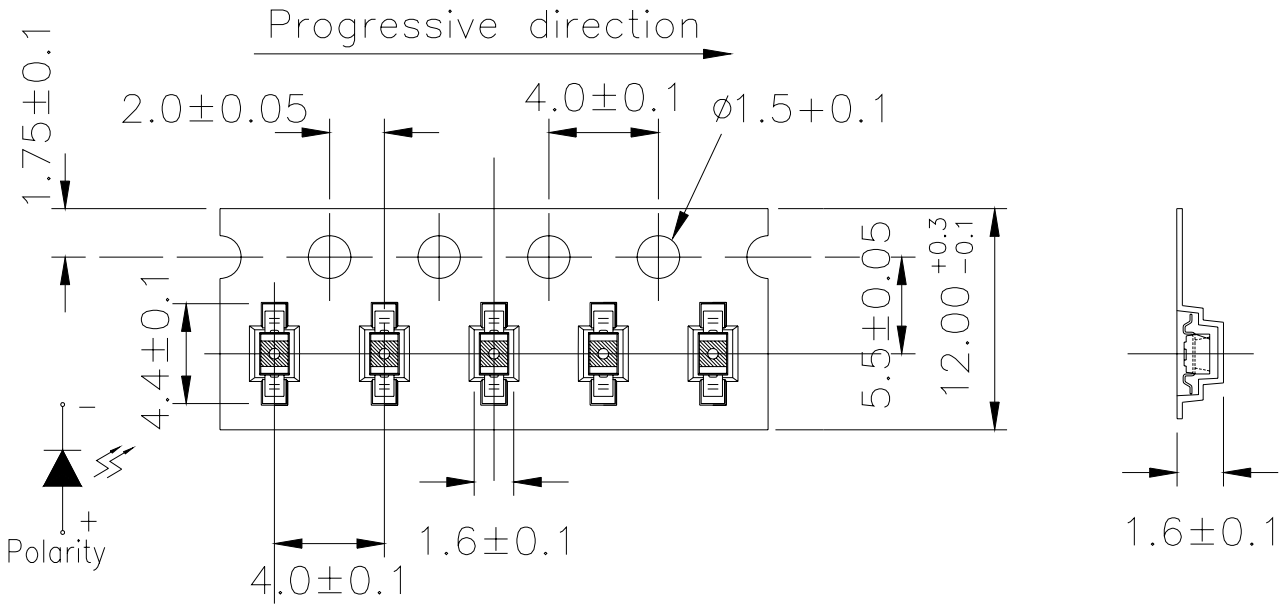
Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel.



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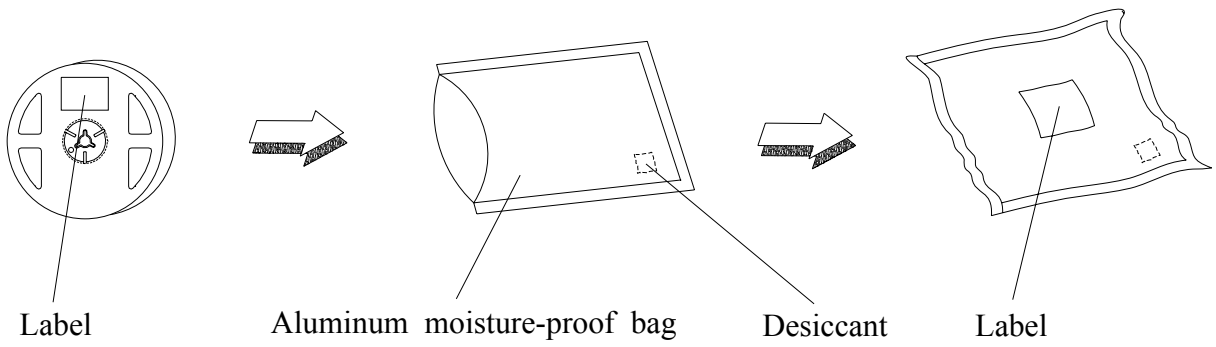
Moisture Resistant Packaging



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Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level：90%

LTPD：10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260℃±5℃ Min. 5sec.	6 min	22 PCS.	0/1
2	Temperature Cycle	H : +100℃ 15min ∫ 5 min L : -40℃ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100℃ 5min ∫ 10 sec L : -10℃ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I_F = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

Technical Data Sheet

Mini Top LEDs (Reverse Gull Wing)

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Precautions for Use

1. Over-current-proof

   Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

   2.1 Do not open moisture proof bag before the products are ready to use.

   2.2 Before opening the package: The LEDs should be kept at 30℃ or less and 90%RH or less.

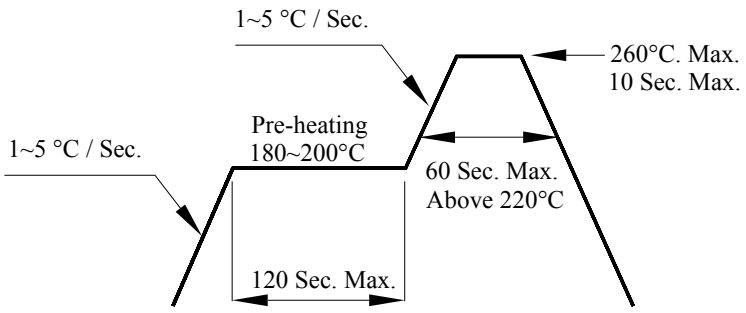
   2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

   2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

   Baking treatment: 60±5℃ for 24 hours.

3. Soldering Condition

   3.1 Pb-free solder temperature profile



   3.2 Reflow soldering should not be done more than two times.

   3.3 When soldering, do not put stress on the LEDs during heating.

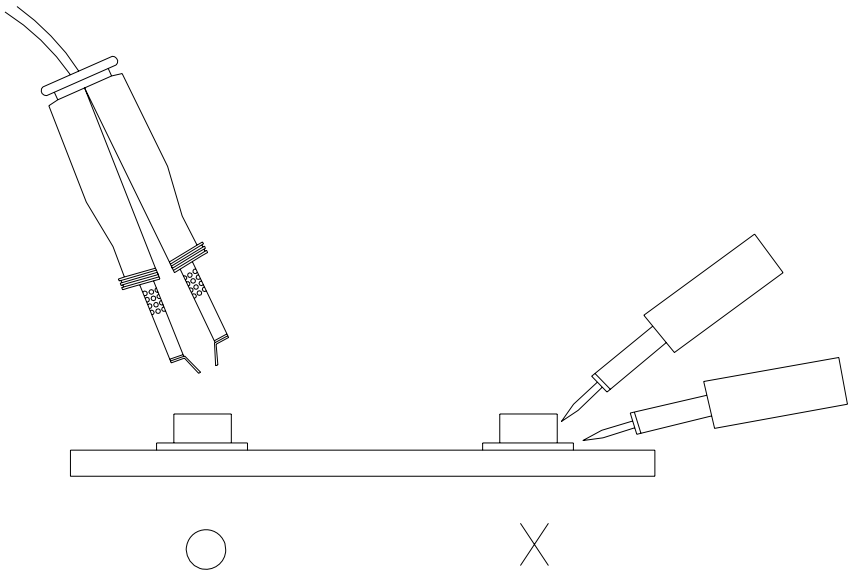
   3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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